

## PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Erik Visser</td> <td>01/16/2013</td> </tr> <tr> <td>Michael Joseph Contour</td> <td>01/16/2013</td> </tr> <tr> <td>Eric S. Mattis</td> <td>02/15/2013</td> </tr> <tr> <td>Joseph Robert Fitzgerald</td> <td>01/28/2013</td> </tr> <tr> <td>Kwokleung Chan</td> <td>01/17/2013</td> </tr> </tbody> </table>		Name	Execution Date	Erik Visser	01/16/2013	Michael Joseph Contour	01/16/2013	Eric S. Mattis	02/15/2013	Joseph Robert Fitzgerald	01/28/2013	Kwokleung Chan	01/17/2013
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Eric S. Mattis	02/15/2013												
Joseph Robert Fitzgerald	01/28/2013												
Kwokleung Chan	01/17/2013												
RECEIVING PARTY DATA													
Name:	QUALCOMM Incorporated												
Street Address:	5775 Morehouse Drive												
City:	San Diego												
State/Country:	CALIFORNIA												
Postal Code:	92121-1714												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13664615</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13664615								
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Application Number:	13664615												
CORRESPONDENCE DATA													
Fax Number:	8016062774												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone:	801-537-1700												
Email:	wla-admin@austin-rapp.com												
Correspondent Name:	Wesley L. Austin												
Address Line 1:	170 S. Main St., Ste. 735												
Address Line 4:	Salt Lake City, UTAH 84101												
ATTORNEY DOCKET NUMBER:	112886U1												
NAME OF SUBMITTER:	Wesley L. Austin												
Signature:	/Wesley L. Austin/												

OP \$40.00 13664615

Date:

04/29/2013

**Total Attachments: 15**

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ASSIGNMENT

WHEREAS, WE,

1. **Erik Visser**, a citizen of **Luxembourg**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
2. **Michael Joseph Contour**, a citizen of **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
3. **Eric S. Mattis**, a citizen of **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
4. **Joseph Robert Fitzgerald**, a citizen of **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
5. **Kwokleung Chan**, a citizen of **Hong Kong**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **OPTIMIZING AUDIO PROCESSING FUNCTIONS BY DYNAMICALLY COMPENSATING FOR VARIABLE DISTANCES BETWEEN SPEAKER(S) AND MICROPHONE(S) IN A MOBILE DEVICE** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). **13/664,615** filed **October 31, 2012**, QUALCOMM Reference No. **112886U1**, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/576,842**, filed **December 16, 2011**, QUALCOMM Reference No. **112886P1**, and with U.S. Provisional Application No(s). **61/616,853**, filed **March 28, 2012**, QUALCOMM Reference No. **112886P2** (and do hereby

authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

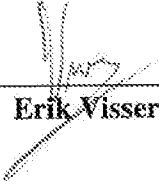
AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at SAN DIEGO, on 11/16/2013  
LOCATION DATE   
Erik Visser

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Michael Joseph Contour

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Eric S. Mattis

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Joseph Robert Fitzgerald

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Kwokleung Chan

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WHEREAS, WE,

1. **Erik Visser**, a citizen of **Luxembourg**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **OPTIMIZING AUDIO PROCESSING FUNCTIONS BY DYNAMICALLY COMPENSATING FOR VARIABLE DISTANCES BETWEEN SPEAKER(S) AND MICROPHONE(S) IN A MOBILE DEVICE** (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said **INVENTIONS**, including all patent applications therefor that may have been filed or may be filed hereafter for said **INVENTIONS** in the United States, including but not limited to U.S. Application No(s). **13/664,615** filed **October 31, 2012**, QUALCOMM Reference No. **112886U1**, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/576,842**, filed **December 16, 2011**, QUALCOMM Reference No. **112886P1**, and with U.S. Provisional Application No(s). **61/616,853**, filed **March 28, 2012**, QUALCOMM Reference No. **112886P2** (and do hereby

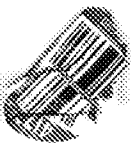
authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;



AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Erik Visser

Done at SAN DIEGO, CA, on 1/16/13 *Michael Joseph Contour*  
LOCATION DATE Michael Joseph Contour

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Eric S. Mattis

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Joseph Robert Fitzgerald

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Kwokleung Chan



## ASSIGNMENT

WHEREAS, WE,

1. Erik Visser, a citizen of Luxembourg, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.
2. Michael Joseph Contour, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.
3. Eric S. Mattis, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.
4. Joseph Robert Fitzgerald, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.
5. Kwokleung Chan, a citizen of Hong Kong, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **OPTIMIZING AUDIO PROCESSING FUNCTIONS BY DYNAMICALLY COMPENSATING FOR VARIABLE DISTANCES BETWEEN SPEAKER(S) AND MICROPHONE(S) IN A MOBILE DEVICE** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/664,615 filed October 31, 2012, QUALCOMM Reference No. 112886UI, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/576,842, filed December 16, 2011, QUALCOMM Reference No. 112886P1, and with U.S. Provisional Application No(s). 61/616,853, filed March 28, 2012, QUALCOMM Reference No. 112886P2 (and do hereby

authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

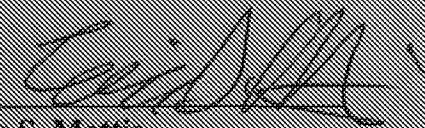
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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Erik Visser

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Michael Joseph Contour

Done at San Diego, CA, on February 15, 2013   
LOCATION DATE Eric S. Mattis

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Joseph Robert Fitzgerald

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Kwokleung Chan

**ASSIGNMENT**

WHEREAS, WE,

1. **Erik Visser**, a citizen of **Luxembourg**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **OPTIMIZING AUDIO PROCESSING FUNCTIONS BY DYNAMICALLY COMPENSATING FOR VARIABLE DISTANCES BETWEEN SPEAKER(S) AND MICROPHONE(S) IN A MOBILE DEVICE** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). **13/664,615** filed **October 31, 2012**, QUALCOMM Reference No. **112886U1**, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/576,842**, filed **December 16, 2011**, QUALCOMM Reference No. **112886P1**, and with U.S. Provisional Application No(s). **61/616,853**, filed **March 28, 2012**, QUALCOMM Reference No. **112886P2** (and do hereby

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Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Erik Visser

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Michael Joseph Contour

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Eric S. Mattis

Done at \_\_\_\_\_, on 1-29-13  
LOCATION DATE  Joseph Robert Fitzgerald

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Kwokleung Chan

## ASSIGNMENT

WHEREAS, WE,

1. **Erik Visser**, a citizen of **Luxembourg**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **OPTIMIZING AUDIO PROCESSING FUNCTIONS BY DYNAMICALLY COMPENSATING FOR VARIABLE DISTANCES BETWEEN SPEAKER(S) AND MICROPHONE(S) IN A MOBILE DEVICE** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). **13/664,615** filed **October 31, 2012**, QUALCOMM Reference No. **112886U1**, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/576,842**, filed **December 16, 2011**, QUALCOMM Reference No. **112886P1**, and with U.S. Provisional Application No(s). **61/616,853**, filed **March 28, 2012**, QUALCOMM Reference No. **112886P2** (and do hereby

authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;



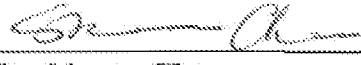
AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Erik Visser

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Michael Joseph Contour

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Eric S. Mattis

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Joseph Robert Fitzgerald

Done at San Diego, on Jan 17, 2013  
LOCATION DATE   
Kwokleung Chan